

Product Summary

V _{(BR)DSS}	R _{DS(on)TYP}	I _D
80V	3.5mΩ@10V	130A



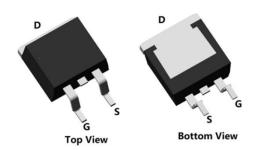
Feature

- Fast Switching
- Low Gate Charge and Rdson
- Advanced Split Gate Trench Technology
- 100% Single Pulse avalanche energy Test

Applications

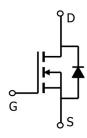
- Power switching application
- DC-DC Converter
- Uninterruptible power supply

Package



TO-263(1:G 2:D 3:S)

Circuit diagram



Marking



SP80N03BGHTD : Device Code
** : Week Code

Order Information

Device	Package	Unit/Tape		
SP80N03BGHTD	TO-263	800		

80V N-Channel Power MOSFET

Absolute maximum ratings (Ta=25°C,unless otherwise noted)

Parameter	Symbol	Rating	Unit
Drain-Source Voltage	V _{DSS}	80	V
Gate-Source Voltage	V _{GSS}	±20	V
Continuous Drain Current (Tc=25°C)	I _D	130	A
Continuous Drain Current (Tc=100°C)	Ι _D	90	A
Pulse Drain Current Tested	I _{DM}	520	А
Single Pulse Avalanche Energy ¹	E _{AS}	576	mJ
Power Dissipation (Tc=25°C)	PD	160	W
Thermal Resistance Junction-to-Case	Rejc	0.78	°C/W
Maximum Junction Temperature	TJ	-55 to 150	°C
Storage Temperature Range	T _{STG}	-55 to 150	°C

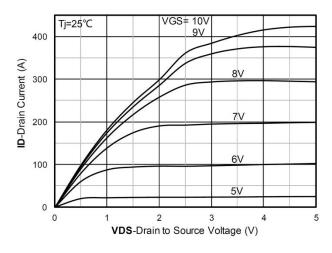
Electrical characteristics (Ta=25°C, unless otherwise noted)

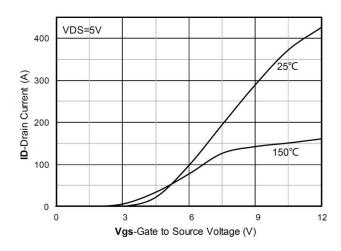
Characteristics	Symbol	Test Condition	Min	Тур	Max	Unit	
Static Characteristics							
Drain-Source Breakdown Voltage	BV _{DSS}	$I_D = 250 \mu A, V_{GS} = 0 V$	80	-	-	V	
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} = 64V, V _{GS} = 0V	-	-	1	uA	
Gate Leakage Current	I _{GSS}	$V_{GS} = \pm 20V, V_{DS} = 0V$	-	-	±100	nA	
Gate Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	2.0	3.0	4.0	V	
Drain-Source On-state Resistance	R _{DS(ON)}	V _{GS} = 10V, I _D = 20A	-	3.9	4.8	mΩ	
Dynamic Characteristics	_						
Input Capacitance	C _{iss}		-	4360	-		
Output Capacitance	Coss	VGS=0V, VDS=40V,F=1MHz	-	500	-	pF	
Reverse Transfer Capacitance	C _{rss}			26	-		
Total Gate Charge	Qg	VDS=40V, VGS=10V, ID=20A		42	-	nC	
Gate-Source Charge	Q _{gs}			15	-		
Gate-Drain Charge	Q_{gd}			20	-		
Switching Characteristics							
Turn-On Delay Time	t _{d(on)}		-	17	-		
Rise Time	t _r	\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\	-	39	-		
Turn-Off Delay Time	t _{d(off)}	VDD=40V, ID=20A, VGS=10V, R_G =3 Ω	-	64	-	nS	
Fall Time	t _f	1		42	-		
Drain-Source Body Diode Characteristics							
Source-Drain Diode Forward Voltage	V _{SD}	VGS=0V , IS=1A , TJ=25℃	-	-	1.2	V	
Maximum Body-Diode Continuous Current	Is		-	-	130	Α	
Reverse Recovery Time	Trr	I _S =50 A,di/dt=100 A/μs, T _J =25°C		45	-	nS	
Reverse Recovery Charge	Qrr			56	-	nC	

Note:

1. The test condition is VDD=40V,VGS=10V,L=0.5mH,RG=25 Ω

Typical Characteristics

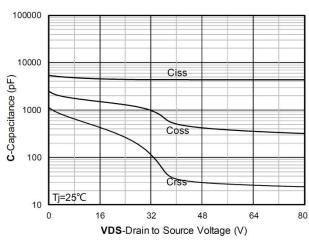


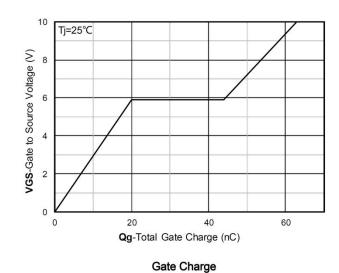


Output Characteristics



Transfer Characteristics

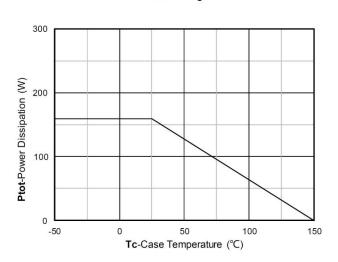




Capacitance Characteristics

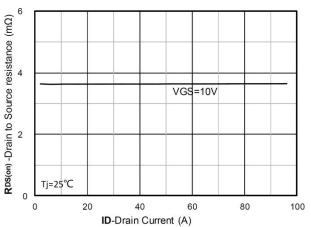
150 (A) 100 treating 50 0 -50 0 50 100 150 Tc-Case Temperature (°C)

Current dissipation

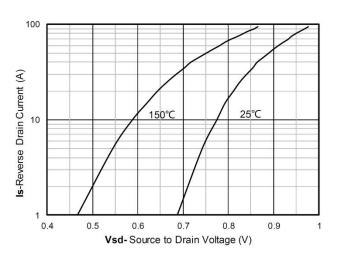


Power dissipation

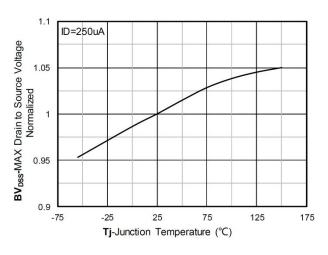




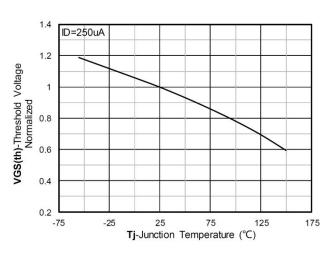
RDS(on) VS Drain Current



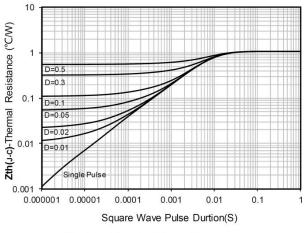
Forward characteristics of reverse diode



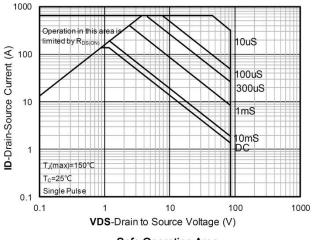
Normalized breakdown voltage



Normalized Threshold voltage



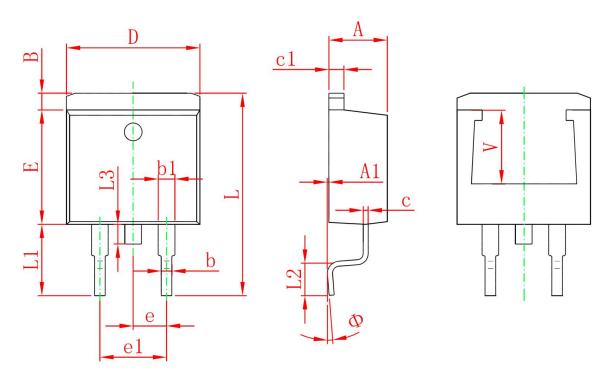
Maximum Transient Thermal Impedance



Safe Operation Area



TO-263 Package Information



	Dimensions In Millimeters		Dimensions In Inches		
Symbol	Min.	Max.	Min.	Max.	
A	4.470	4.670	0.176	0.184	
A1	0.000	0.150	0.000	0.006	
В	1.120	1.420	0.044	0.056	
b	0.710	0.910	0.028	0.036	
b1	1.170	1.370	0.046	0.054	
С	0.310	0.530	0.012	0.021	
c1	1.170	1.370	0.046	0.054	
D	10.010	10.310	0.394	0.406	
E	8.500	8.900	0.335	0.350	
е	2.540	2.540 TYP.		0.100 TYP.	
e1	4.980	5.180	0.196	0.204	
L	14.940	15.500	0.588	0.610	
L1	4.950	5.450	0.195	0.215	
L2	2.340	2.740	0.092	0.108	
L3	1.300	1.700	0.051	0.067	
Ф	0°	8°	0°	8°	
V	5.600 REF.		0.220 REF.		